

HW Repair Guide SM-G7102 (Galaxy Grand 2)

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Samsung GALAXY GRAND 2

Q&A

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Specification

Item	Specification
AP	One chip solution
СР	MSM8226 A7 Cortex Quad Core @ 1.2GHz
OS	Android 4.3 (Jelly Bean MR2)
Memory	8GB (eMMC) + 1.5GB (LPDDR2, POP)
Display	5.25" HD (TFT)
Camera	8M AF + LED Flash, 1.9M FF
Sensor	Proximity, Light, Accelerometer, Hall Sensor
FM Radio	0
Connectivity	BT4.0, WiFi a/b/g/n
GPS	A-GPS + GLONASS
Battery	2600mA
Speed	HSPA+ 21Mbps

Introduction of GRAND2 3G (2/3)

• Features

Optimal Wide View

- Satisfying Viewing Experience
- Maximize Every Inch
- 1. Optimized for Media playing
- ✔ 16:9 HD display
- Perfect Ratio for Movie
 - 2. Big Screen Experience
- Larger Viewing Area
- Clearer
 - 3. Easy Multi Tasking
- Multi Window & Easy Sharing

Smart Service for Smart Life

- Entertaining and Fun
- Refined Usability
- **1. Premium Experience**
- S View Cover
- Perfect Ratio for Movie

2. Fun

- Sound & Shot
- 🖌 Group Play
- S Translator
- Story Album

Introduction of GRAND2 3G (3/3)

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Galaxy Grand	Category	Galaxy Grand2
5.01" TFT WVGA (800 x 480)	Lager and High Resolution Display	5.25" TFT HD (1280 x 720)
8M w/LED	Camera	8M w/LED, BIS, Zero Shutter Lag
Broadcom Capri ARM Coretex-A9 Dual 1.2GHz	Application Processor	Qualcomm MSM8226 ARM Coretex-A7 Quad 1.2GHz
2100mAh	Battery	2600mAh
GFF	Slim TSP	Slim GFF
1GB DDR2 8GB eMMC	Memory	1.5GB DDR2 8GB eMMC
2G EDGE Rx Quad 3G HSPA+ 21Mbps Triple (1,2,8)	Network	2G EDGE Rx Quad 3G HSPA+ 21Mbps Quad(1,2,5,8)

RF calibration (1/2)

★ For GRAND2(SM-G7102), new IF cable should be used for IMEI writing and Calibration. (Detailed information : Refer SVC Bulletin (12-37) New IF Cable Guide.)

1. Run Baroserver program.

- Extract "BaroServer_Ver_1.0.6.zip" and Run "setup.exe"
- Click Next to install the program. Run BaroServer Launcher at the desktop.
- Enter 'Assistant Server IP', same as 'Host Server IP'.
- Check SVC Only (5555) option and input password.
- Click 'START' button and check if "Running" message appears.

	arometer Server				0
	SERVER CONTROL	CONFIG		INSTRUMENT	
	Ver 1.0.6.0	TCP Port Serial Port 3003 COM1 Oscietant Server IP Interval (ser)	 Dummy Read Data SVC Only (9895) 	Service Data hPa Gathering time	
	Stop	Host Server IP Baud : 19200 10.244.114.62 1	tos Détai Log	Assistant Read Data	
BaroServer	SEVER INFORM Host Server : Stop Assistant Server : Stop	Connected Clier		CONSIGNATION TAKE	0
Launcher	Instrument : Stop	Service Count per min			OK
	D TIME REMOT	I P/PORT UN DATA(h	OG OUTPUT DATALTIME STAT	тиз деяскиртю	ART
				S	TOP

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2. Run Calibration program

Category	Filename	Remark
Launcher	DASEUL_Launcher_v3.0.20.exe	
Runtime file	DASEUL_CAL_ALL_Runtime_3.1.93.0_r00061.CAB or later version	Folder Name : SM-G7102 (under Launcher folder)
Model File	SM-G7102_COMMON(CSC)_IMEI_Ver_3.1.92.0.CAB or later version	Folder Name : SM-G7102 (under Launcher folder)



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IMEI Writing (1/4)



★ For GRAND2 3G(SM-G7102), new IF cable should be used for IMEI writing and Calibration. (Detailed information : Refer SVC Bulletin (12-37) New IF Cable Guide.)

1) Run Daseul Program for IMEI Writing

Category	Filename	🔒 DASE	EUL Launcher for Service Ver 3.0.5			×
Launcher	DASEUL_SVC_ Launcher_v3.0.20.exe	< Laun	Processing	MODE	: Service Status	•
Runtime File	DASEUL_IMEI_ALL_Runtime_ 3.1.93.0_r00074.CAB or later version	1	::: Start Normal Mode for Service :		Complete	
Model File	SM-G7102_COMMON(CSC)_ IMEI_Ver_3.1.92.0.CAB or later version					
		Selec	ct Extract Process D:₩업무₩Daseul			
		[MODEL]	•	System Se	tting
		SI	IMD F/T			

Calbration
Final Auto
Final Manual
MEI

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Extract & Run

Close

IMEI Writing (2/4)

2) Select MODE as 'Service', Model folder as 'SM-G7102', check IMEI option and click System Setting button.

3) Check 'IMEI Write' and 'IMEI Check' option, and click 'IMEI SVC & Repair Option' to check 'SVC' option.

👌 DASEUL Launche	for Service Ver 3.0.5			يبير 🔤	Sc	t S	vetom Confi	auration			X
< Launcher Status	>	MODE :	Service 👻		Set Sys	tern Cor		guradori			
No. Processing Select Extract Pr [MODEL] @ Runtime SMD F/T @ PBA F/T	BM-G7102 2 - DASEUL_Runtime_Ver_3.1.36.1	.CAB	System Setting	Test Process – [Process] SMD F/T PBA F/T Calibration Final Auto Final Manual IMEI Write IMEI Check SVC Board MDL Rework IMEI Read STA Write STA Check STA Reset			Test Condition IMEI SVC && Repair Option FTR N/A SVC DEVELOPE Romania SVC Initial PGM ATT Rework	System	Config. rk N/A MIAMI N/A r Board htina SKD y kia SVC		Model Information Hardware Config
Calibration Final Auto Final Manual Image Imer	8M-G7102 COMMON(CSC16G)_1	MEI_Ver_3.1	.36.4.CAB	GPS WLAN Power Off-Or Bluetooth LCIA Proces	before WL		IMEI SVC&Repair Option	OK CAN	eration	RUN SeeLog	End Band

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IMEI Writing (3/4)

- 4) Click 'Hardware Config' option.
- 5) Click 'Port Setting' in the phone option, and select correct port for IMEI writing.
- 6) Click Save and OK to enter IMEI writing program.

346	Sat	System Configurati	on [۲
	Set System		UII	Set IO BUS Configuration	
Test Process -	[Master] [Sla	Test Condition Calibration Real CAL Cycle: on every	System Config. Language English Model Informatio	Phone Count 1 Phone IO Bus Setting	
SMD F/T	ГГ	20 💌 default CALs	Line Name LINE(temp)	I/F - 1 Type Serial COM Y Common	
PBA F/T Calibration		,	Line Type Block Cell	I/F - 2 Type N/A Port Setting BaudRate 115200 V	
Final Auto	ПП	Calibration Mode : FDT	# of Phone 1	Data Bit 8	
Final Manual	ПГ	Final Conduction	Start Number		
IMEI Write IMEI Check			of Jig		
SVC Board MDL Rework			IP Address 10.244.114.62		
IMEI Read STA Write STA Check STA Reset		Test Signal Mode : Signaling 💉 Developer Mode	SKD Mode	MSTS Count 0	
WLAN	ГГ		, chiltrato		
GPS	ГГ	Use RFSM	500mg	I/F Type GPIB	SAVE
WLAN Power Off-On	before WI AN		End Band	Port Setting	
Bluetooth LCIA Process	s Order	IMEI SVC&Repair Option	Operation Condition Condition RUN SeeLog OK	A Barometer I/O Type TCP/IP ▼ Port Setting	Cancel

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IMEI Writing (4/4)

- 7) Enter IMEI number and click 'Apply' button.
- 8) Click 'Model Info' button and input 'SKU_CODE' and 'BUYER', then click Save.
- **X** SKU_CODE can be found in HHPsvc > ESN/IMEI Review
- 9) Click 'Start' button and Input 'User ID' and 'Password'.
- 10) Click 'Login' button and connect the phone to Anyway JIG.

4		1.0 months	DASEUL - GT-80	00 IDi / Permisa	on: Operator]		- X	2			DASEUL - GT	19306 [ID: / Permit	eex Operator]		
Model PCM Ver	SM-67102 DASEUL_201361	SIW Ver SIW Ver Process	PV 5,100 8300000118 MEI Write(M) - MEI Che	sku CSC ck(M) Service	6T-REDEDCOTON RECORDEDCOTON	DB Sev HOME (SUBAL Cell Type DBoyer 1 TUR DPC NO.)	Rick Cell Fit	Model	SM-G7102	HW Ver	PV 1.100 19300XXLE8	SKU CSC	GT-0300RWDBTU 03000JVALE9	DB Se Buye	W HOME(GUI
			Phone 01					PGM Ver	DASEUL_v3.1.36.1	Process	MEI Write(M) - IMEI	Check(M) Service			
Star	un Prom (STAR	TALL] Button!	D.								Phone 01				
Res	ult: None							Control of Control	0						
Tie	0.0 second (A	verage : 0.0 se	ondi					Status	Press [START AL	rrl Batton:					
Fail	(%) Total Test: 0,	Test Fail: 0 (Rat	e: 0.0%)					Result	None						
u(N) + -								Time	0.0 second (Amer	0.0 **	condi				
1 Ph	one 01			(RFS	M Not Use 3 🚊 🐧			Caller	Total Tost 0 Tost	5-1 0/5	IMEI Writing Items				
[Matus] Pho	nell Result Phonell	Intel PhoneEE	MEI Phonetil Nerson Int	C PHEAR	100	T: 0 PT	0(0.0%)	Eau(%)	ictal lest: 0, lest	raii: u (R	Software	19300001.E8			
MEINUM,	uuu · [ii ·] uuu					SAMSUNG	100	U/N : -			Hardware	PV 1,100		10	
E MERT	sove) · · ·		SN Num			ELECTRON	ICS	n			CSC	193000JVALE9			1000
Lock Br Code Fr	fing eld				1004			Phor	ne 01		PDA	19300CCALE9			
Network	UnLock Key				100			[Status] Phone0	1 (Result) Phone01 (Info)	Phone01	Software2	1			
SP UHL	ock Key				Made			MEI Num.	11111 - 11 - 111111	1	LPD			1	-
Master	Cep.		_		340		Start	IMEI Num/Sla	ve)		Contents				SUMSO
							otart	= MEPerso	nal Lock	_	DMB				
							Ston	Lock Settin	9		SKULCODE	GT-ISSOORWDBTU			
							2017	Code Field	dash Kau	_	BUYER	BTU			
							Reset	Subset Uni	Lock Key	_	1 STA SKILLOUDE	1		-	
								SP UnLock	: Key		Save	Loed	Cancel		
2			5 6			A	0	Master Ke	/						
AM			nrg festhers				-								
1 Vote Date	Introduce from 100	all installe	a Cadula Total			STREET, STREET, STREET, ST.									

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Emergency download mode & Odin T-Flash mode





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Boot Recovery (1/6)

Brief Process

- 1) Preparing SD card, using working GRNAD2 3G (Samsung Method)
- 2) Inserting the SD Card to "eDL mode "phone for recovering.
- 3) Downloading the boot loader file to the defective phone, and Flash Full S/W (Pit, BL,AP, CP, CSC)

Pre-requisite

- 1) 1 Working GRAND2 3G phone (Consisting of T Flash Enabled Binary)
- 2) External SD card (Memory Size should be 8GB or bigger)
- 3) [SD card size should be more than the PIT file, Else the repartitioning of PIT file will fail]
- 4) Odin3 v3.07.exe and Odin3.ini
- 5) Latest PIT and Boot loader file



Boot Recovery (2/6)

EDL mode verification

- Device not booting up
- Confirming a device is in Emergency Download mode (eDL mode).
 - 1) Attach the faulty device to Windows PC
 - 2) Go to Device Manager
 - 3) You should able to see below item in Ports.



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Boot Recovery (3/6)

- Insert External SD Card to normal phone to copy Boot loader to SD card
- Go to download mode (Vol Dn + Home Key + Power, Vol Up)
- Run Odin3 v3.07.exe with options enabled as shown
- Click on start button to download the binary into SD Card.

📮 Odin3 v3.07	
Odin3 Model Name :)	
ID:COM	
Option Image:	Re-Partition PIT \Users\punith\Desktop\Novemeber 11\Hudson Binary\MS013G_EUR_OPEN_8G.pit
T Flash Dump AP RAM	Files [Download] G7102XXEAMK6_2102559_REV00_eng_mid_noship_MULTI_CERT.tar.md5
Phone Bootloader Update Phone EFS Clear Message <osm> Enter CS for MD5</osm>	PDA PHONE
<osm> Check MD5 Do not unplug the cable <osm> Please wait <osm> BL_G7102XXEAMK6_2102559_REV00_eng_mid_nosl <osm> Checking MD5 finished Successfully <osm> Leave CS</osm></osm></osm></osm></osm>	UMS
	File [Dump] Open
	Start Reset Exit

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Boot Recovery (4/6)

- Use the SD card to recover a device going to eDL mode.
- Plug in the SD Card on to the device which is in eDL mode.
- Remove the Battery and put it back.
- make it to download mode with Volume Down + Power key and press Home key

Mode : Volume Down key + Home key + Power Key and press
 Volume Up key.



< Volume Down key + Home key + Power Key >

< Download Mode >

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Boot Recovery (5/6)

• Flash the Latest Pit and Boot loader on to the device (as shown below)

Odin3 v3.07					
Odin3 Model Name :)			Ę		
ID:COM					
0:[COM4]					
Option	Re-Par	tition			
Auto Reboot Re-Partition F. Reset Time		PIT V	Isers\punith\Desktop\Novem	eber 11\Hudson Binary\M	S013G_EUR_OPEN_8G.pit
Flash Lock LED Control Nand Erase All	=				
T Flash	Files [D		G7102XXEAMK6 2102	559 REVOD end mid nos	hin MULTI CERT tar md5
Dump AP RAM 👻		Bootloader			
Phone Bootloader Update Phone EFS Clear		PDA			
Message		PHONE			
<id:0 004=""> Added!!</id:0>			, 		
<osm> Check MD5 Do not unplug the cable <osm> Please wait</osm></osm>					
<osm> BL_G7102XXEAMK6_2102559_REV00_eng_mid_nosl <osm> Checking MD5 finished Sucessfully</osm></osm>		UMS			
<osm> Leave CS</osm>	File [D)ump]			
					Open
			Start	Reset	Exit
	_				



Boot Recovery (6/6)

- Now remove the SD Card from Faulty device.
- Go to download mode (Vol Dn + Home + Power Key, Vol Up)
- Select all the binaries (Pit, BL, AP, CP, CSC) in Odin.
- Click on Start button to download

Odin3 v3.07			_ _ ×
Odin3 Model Name :)	/	-	
ID:COM			
Dption	Re-Pai	rtition	
Auto Reboot Re-Partition F. Reset Time		PIT E:	:\ms013g\MainBinary\MS013G_EUR_OPEN_8G.pit
	Files [[Download]	
		Bootloader	E:\ms013g\MainBinary\BL_G7102XXUAMK6_2119707_REV00_user_low_ship_
Phone Bootloader Update Phone EFS Clear	V	PDA	E:\ms013g\MainBinary\AP_G7102XXUAMK6_2119707_REV00_user_low_ship_
lessage		PHONE	E:\ms013g\MainBinary\CP_G7102XXUAMK6_2119707_REV00_user_low_ship
<osm> Enter CS for MD5 <osm> Check MD5 Do not unplug the cable <osm> Please wait</osm></osm></osm>		CSC	E:\ms013g\MainBinary\CSC_OXA_G7102OXAAMK6_2119707_REV00_user_lc
<osm> CP_G7102XXUAMK6_2119707_REV00_user_low_shi</osm>		LING	



Disassembly & Assembly Instruction



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Disassemble Instruction

1) Disassemble LCD connector protect cover.

X Caution

1) Be careful of scratch and molding damage.

2) Separate the LCD connector.

🔆 Caution

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- 1) Be careful of scratch and molding damage.
- 2) Be careful of damage to the FPCB.







Disassemble Instruction

3) Displace the temperature chamber for 10 minute Detach the TSP/LCD Assay using Vaccum jig



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AIR pressure 5~7 kgf/cm



X Caution

- 1) Before disassembling, Use heating chamber.
- 2) Be careful of scratch and molding damage.

Disassemble Instruction

4) Unscrew the 10 points.



X Caution1) Be careful of scratch and molding damage.

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Disassemble Instruction

5) Detach the PBA/Sheildcan Assay.

X Caution

1) Be careful of damage to the EARJACK Module.

2) Be careful of damage to the CAMERA.



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6) Disassemble the RCV, Sensor, SPK from PBA. Unscrew the 2 points.

🔆 Caution

- 1) Be careful of damage to RCV.
- 2) It pushes this part at disassembly, and lift it



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7) Separate the VGA, MEGA Camera from PBA Array.

X Caution1) Be careful of damage to the TSP FPCB.



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Disassemble Instruction

8) Separate the Top dummy, Bottom dummy & Speaker from hook.

X Caution

- 1) Be careful of scratch and molding damage.
- 2) Be careful of damage to the TSP & LCD.



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1) Assemble the Top dummy, Speaker on shield can.

X Caution1) Be careful of damage to the part.



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Assemble Instruction

2) Assemble the PBA on Shieldcan. Screw the 2 points..

X Caution

1) Be careful of damage to the part.



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3) Assemble PBA assay to the Rear Assemble Bottom dummy on the Rear

X Caution

1) Be careful of damage to PBA



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Assemble Instruction

4) Remove the TSP tape (in case of replacing the new TSP module)

X Caution1) Be careful of damage to each module.

5) Attach the TSP tape

(in case of replacing the new TSP module)





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Assemble Instruction

6) Screw the 10 points of the Rear.1.2 ± 0.1 Kgf/cm².

※ Caution

1) Be careful of scratch and molding damage.



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7) Attach the LCD assay to the Rear Assay.8) Assemble LCD connector.

X Caution

1) Be careful of scratch and molding damage.





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9) Assemble LCD connector protect cover.

X Caution

1) Be careful of scratch and molding damage.



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Assemble Instruction

10) Press the set using pressure jig.

X Caution

1) - Pressure : 5~6 kgf/cm2

- Press time : 9.7 sec .





Electronic Components



Electronic Components (1/2)



GH31-00669A

GH96-06728A

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Electronic Components (2/2)





SMD parts (TOP side)

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SMD parts (Bottom side)

ELECTRONICS





Troubleshooting



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Power problem



Step	Check point	Result value	Defect point
1	Confirm the defect symptom	-	-
2	Check the new or with a new bettery	Solved	Battery
2	Check the power with a new battery	Not solved	Go to the next step
		High current (over than 1A)	Circuit short
2	Check the PBA current with a power supply	Low current	S/W download
3	(power supply voltage : 3.8 ~ 4.0V)	Normal current	Display or Power key
		No current (almost 0mA)	Go to the next step
4	Check the V _{batt} (+point) of battery contact	C425 = 3.8V (same as power supply voltage)	Go to the next step
	Juli	If not the correct value	PMIC (U401)
5	Check the voltage of following chips (C561,C558,C556,C559,TP(AP_PS_HOLD))	C484,C485 = 1.15V C466 = 1.3V C467 = 2.1V R420 (MSM_PS_HOLD) > 1.8V	Go to the next step
		If not the correct value	PMIC (U401)
6	Check the frequency of OSC400	19.2MHz	Main chip (UCP300)
6		If not the correct value	X-tal (OSC400)

Power problem







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Step	Check point	Result value	Defect point
1	Confirm the defect symptom (Make a call, check the debug screen *#0011#)	-	-
2	Check the settings (airplane mode, Mobile networks)	Abnormal Normal	Settings Go to the next step
3	Check the status main ANT	Broken, dust, corrosion No insert	Main ant
		Normal	Go to the next step
4	Power on with a power supply (power supply voltage : 3.8V)	-	-
	Check the status(crack, missing, Corrosionetc) of RF components.	Abnormal status (compared with a good PBA)	RF components.
5	ANT101 (ANT contact) U106 (Tx module, PAM) U101 (B1,B8 PAM) F102,F104 (B1,B8 DUF) U104 (B2,B5 PAM) U610,F105 (B2,B5 DUF) F101(Saw Filter) U102 (Transceiver)	Normal status (compared with a good PBA)	CP(Call Processor) (UCP300)







Step3





Step5



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BT/WIFI



Step	Check point	Result value	Defect point
1	Confirm the defect symptom (Check the turned on BT/WIFI & connected device)	Turned on	Go to the next step
1		Turned off	Turn on
C	Check the BT/WIFI Ant. & Ant contact. (Rear cover Ant. & ANT201)	Broken, dust, corrosion	Ant & ANT201
2		Normal	Go to the next step
3	Power on with a power supply (power supply voltage : 3.8V)	-	-
4	Check the voltage of C201,C200,C222 Notice. It should be measured when the BT/WIFI path is activated on	C201 = 1.3V C200 = 3.0V C222 = 1.8V	Go to the next step
		If not the correct value	PMIC (U401)
5	Check the clock of C203 Notice. It should be measured when the BT/WIFI is activated on	C203 = 48MHz (Same signal compared with a good PBA)	Go to the next step
		If not the correct value	OSC200
6	Check the status(crack, missing, Corrosionetc) of RF components. C238, L212, ,C237 (ANT Matching) F201,F200,C228 (filter and filter matching) Notice. It should be measured when the BT/WIFI path is activated on	Abnormal status (compared with a good PBA)	RF components.
		If not the correct value	BT/WIFI IC (U201)

BT/WIFI





BT/ WIFI ANTENNA (FPCB TYPE) CONTACT

BT/WIFI



Step4,5





Step	Check point	Result value	Defect point
1	Confirm the defect symptom (Check the turned on GPS function)	Turned on	Go to the next step
I		Turned off	Turn on
2	Check the status Antenna and GPS components.	Broken, dust, corrosion	ANT200 GPS component
	- ANTZOU, CZZO, CZ33, LZO9, FZOZ, CZ34, LZO3	Normal	Go to the next step
3	Power on with a power supply (power supply voltage : 3.8V)	-	-
4	Check the voltage of C245 Notice. It should be measured when the GPS path is activated on	C245 = 2.75V	Go to the next step
4		If not the correct value	PMIC(U401)
_	Check the voltage of C241 Notice. It should be measured when the GPS path is activated on	C241 = 1.8V	Go to the next step
5		If not the correct value	AP(UCP300)
6	Check the clock of C156 Notice. It should be measured when the GPS path is activated on	C156 = 19.2Mhz (Same signal compared with a good PBA)	GPS IC(U102) GPS LNA(U200)
		If not the correct value	OSC200



Step1

Location services

Use wireless networks

Location determined by Wi-Fi and/or Mobile networks

 \checkmark

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Use GPS satellites

Location accurate to street level

Use sensor aiding

Enhance positioning and save power using sensors

Location and Google search

Allows Google to use your location data for improved search results and other services





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Step4,5





Step4,5,6



Step	Check point	Result value	Defect point
1	Confirm the defect symptom	-	-
2	Make a factory reset (*2767*3855#)	Solved	Setting error
2		Not solved	Go to the next step
2	Check the speaker connector (HDC501)	Broken, dust, corrosion	Speaker connector
3		Normal	Go to the next step
Α	Replace the speaker module (GH96-06683A)	Solved	speaker
4		Not solved	Go to the next step
5	Connect a LCD, and power on with a power supply (power supply voltage : 3.8V)	-	-
6	Activate the speaker path (*#0*# → Speaker)	-	-
7	Check the signal of speaker contact (C529,C530)	Same signal compared with a good PBA	PBA
	Notice. It should be measured when the speaker path is activated on	No signal	Audio Codec (U502)

Speaker problem



Step3 Step4



Speaker problem

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Step7





Display Problem

Step	Check point	Result value	Defect point
1	Confirm the defect symptom	-	-
2	Check the LCD connector	Broken, dust, corrosion Insert status	LCD connector (HDC600)
		Normal	Go to the next step
2	Replace the LCD	Solved	LCD
3		Not solved	Go to the next step
4	Connect a LCD and display on with a power supply (power supply voltage : 3.8V)	-	-
	Check the voltage of C606 = 1.8V Notice. It should be measured when the display is activated on	If not the correct value	PMIC(U401)
5		C606=1.8V	Go to the next step
	Check the voltage of C602 > 18V Notice. It should be measured when the display is activated on	If not the correct value	Back light IC(U608)
6		C602>18V	Go to the next step
7	Check the voltage of following chips (C607,C605) Notice. It should be measured when the display is activated on	If not the correct value	U601(panel power supplier)
		C607 = 5V C605 = -1.5 ~ -5V	MAIN CHIP

Display problem

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Touch problem

Step	Check point	Result value	Defect point
1	Confirm the defect symptom	-	-
2	Check the LCD connector (HDC600)	Broken, dust, corrosion	LCD connector (HDC600)
		Normal	Go to the next step
2	Check the TSP connector on LCD module.	Broken, dust, corrosion	TSP connector
3		Normal	Go to the next step
	Replace the TSP	Solved	TSP
4		Not solved	Go to the next step
5	Connect a LCD and display on with a power supply (power supply voltage : 3.8V)	-	-
6	Check the voltage of following chips (C604,C433) Notice. It should be measured when the display is activated on	If not the correct value	C604-> LDO(U605) C433 -> PMIC(U401)
		C604 = 2.8V C433 = 1.8V	Go to the next step
7	Check the Signal of following chips (R601,R602) Notice. It should be measured when the display is activated on	If not the correct value	R601,R602
		Same signal compared with a good PBA	MAIN CHIP or PBA

Touch problem

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Receiver problem

Step	Check point	Result value	Defect point
1	Confirm the defect symptom (*#0*# → Receiver)	-	-
2	Make a factory reset (*2767*3855#)	Solved	Setting error
2		Not solved	Go to the next step
3	Check the receiver connector(HDC601)	Broken, dust, corrosion	connector
		Normal	Go to the next step
	Replace the receiver module (GH59-13770A)	Solved	Receiver
4		Not solved	Go to the next step
5	Connect a LCD, and power on with a power supply (power supply voltage : 3.8V)	-	-
6	Activate the speaker path (*#0*# → Receiver)	-	-
7	Check the signal of C524,C525 Notice. It should be measured when the Receiver path is activated on	Same signal compared with a good PBA	CP (UCP300)
		No signal	Audio codec (U502)

Receiver problem

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Microphone problem

Step	Check point	Result value	Defect point
1	Confirm the defect symptom	-	-
2	Check the microphone hole	Dust	Clean the hole
2		Normal	Go to the next step
2	Check the microphone rubber	Wrong insert	Re-insert
0		Normal	Go to the next step
4	Activate the speaker path (*#0283# \rightarrow Packet Loopback ON)	-	-
5	Check the voltage of C501	1.8V	Go to the next step
	Notice. It should be measured when the microphone path is activated on	If not the correct value	AUDIO CODEC(U502)
6	Check the signal of ZD509,ZD5510 Notice. It should be measured when the microphone path is activated on	Same signal compared with a good PBA	Microphone
		If not the correct value	AUDIO CODEC(U502)

Microphone problem



SIM card detection problem

Step	Check point	Result value	Defect point
1	Confirm the defect symptom	-	-
2	Check the SIM socket & Connector	Broken, dust, corrosion	SIM socket
2		Normal	Go to the next step
3	Power on with a power supply (power supply voltage : 3.8V)	-	-
4	Check the signal of R618 for SIM601(UIM1) R629 for SIM600(UIM2) Notice. It should be measured when the phone is started	3V or 3V clock	Go to the next step
		If not the correct value	Call Processor (UCP300)
5	Check the signal of SIM socket pin1 (C636) (C640) Notice. It should be measured when the phone started	3V	SIM socket
		If not the correct value	PMIC (U401)

SIM card detection problem

C636

C640

R629



Step4

R618

Step5

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Question



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